

HGTP14N36G3VL, HGT1S14N36G3VL, HGT1S14N36G3VLS

(FLANGE)

14A, 360V N-Channel, Logic Level, Voltage Clamping IGBTs

June 1995

Features

- · Logic Level Gate Drive
- Internal Voltage Clamp
- ESD Gate Protection
- T₁ = 175°C
- · Ignition Energy Capable

Description

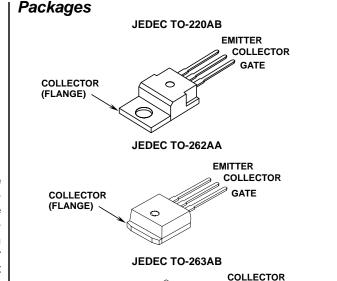
This N-Channel IGBT is a MOS gated, logic level device which is intended to be used as an ignition coil driver in automotive ignition circuits. Unique features include an active voltage clamp between the collector and the gate which provides Self Clamped Inductive Switching (SCIS) capability in ignition circuits. Internal diodes provide ESD protection for the logic level gate. Both a series resistor and a shunt resister are provided in the gate circuit.

PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND
HGTP14N36G3VL	TO-220AB	14N36GVL
HGT1S14N36G3VL	TO-262AA	14N36GVL
HGT1S14N36G3VLS	TO-263AB	14N36GVL

NOTE: When ordering, use the entire part number. Add the suffix 9A to obtain the TO-263AB variant in the tape and reel, i.e., HGT1S14N36G3VLS9A.

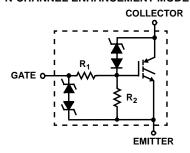
The development type number for this device is TA49021.



Terminal Diagram

GATE #

N-CHANNEL ENHANCEMENT MODE



HGTP14N36G3VL,

Absolute Maximum Ratings	$T_C = +25^{\circ}C$, Unless Otherwise Specified

HGT1S14N36G3VL,	
HGT1S14N36G3VLS	UNITS
390	V
24	V
18	Α
14	Α
±10	V
17	Α
12	Α
332	mJ
100	W
0.67	W/oC
-40 to +175	°C
260	°C
6	KV
	HGT1S14N36G3VLS 390 24 18 14 ±10 17 12 332 100 0.67 -40 to +175 260

NOTE: May be exceeded if $I_{\mbox{\scriptsize GEM}}$ is limited to 10mA.

Specifications HGTP14N36G3VL, HGT1S14N36G3VL, HGT1S14N36G3VLS

Electrical Specifications $T_C = +25^{\circ}C$, Unless Otherwise Specified

				LIMITS			
PARAMETERS	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNITS
Collector-Emitter Breakdown Voltage	BV _{CER}	$I_C = 10$ mA, $V_{GE} = 0$ V $R_{GE} = 1$ k Ω	T _C = +175°C	320	355	400	V
			T _C = +25°C	330	360	390	V
			T _C = -40°C	320	350	385	V
Gate-Emitter Plateau Voltage	V _{GEP}	I _C = 7A, V _{CE} = 12V	T _C = +25°C	-	2.7	-	V
Gate Charge	Q _{G(ON)}	I _C = 7A, V _{CE} = 12V			24	-	nC
Collector-Emitter Clamp Breakdown Voltage	BV _{CE(CL)}	$\begin{array}{c} I_C = 7A \\ R_G = 1000\Omega \end{array} \qquad T_C = +175^{\circ}C$		350	380	410	V
Emitter-Collector Breakdown Voltage	BV _{ECS}	I _C = 10mA	T _C = +25°C	24	28	-	V
Collector-Emitter Leakage Current	I _{CER}	V _{CE} = 250V	$T_{\rm C} = +25^{\rm o}{\rm C}$	-	-	25	μА
		$R_{GE} = 1k\Omega$	$T_{\rm C} = +175^{\rm o}{\rm C}$	-	-	250	μΑ
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	I _C = 7A V _{GE} = 4.5V	T _C = +25°C	-	1.25	1.45	V
			T _C = +175°C	-	1.15	1.6	V
		I _C = 14A V _{GE} = 5V	T _C = +25°C	-	1.6	2.2	V
			T _C = +175°C	-	1.7	2.9	V
Gate-Emitter Threshold Voltage	V _{GE(TH)}	$I_C = 1mA$ $V_{CE} = V_{GE}$	$T_{C} = +25^{\circ}C$	1.3	1.8	2.2	V
Gate Series Resistance	R ₁		T _C = +25°C	-	75	-	Ω
Gate-Emitter Resistance	R ₂		T _C = +25°C	10	20	30	kΩ
Gate-Emitter Leakage Current	I _{GES}	V _{GE} = ±10V		±330	±500	±1000	μА
Gate-Emitter Breakdown Voltage	BV _{GES}	I _{GES} = ±2mA		±12	±14	-	٧
Current Turn-Off Time-Inductive Load	t _{D(OFF)I} + t _{F(OFF)I}	$\begin{split} I_C &= 7A, R_L = 28\Omega \\ R_G &= 25\Omega, L = 550\mu H, \\ V_{CL} &= 300V, V_{GE} = 5V, \\ T_C &= +175^{\circ}C \end{split}$		-	7	-	μs
Inductive Use Test	I _{SCIS}	L = 2.3 mH, $V_G = 5 \text{V},$	T _C = +175°C	12	-	-	А
		v _G = 5v,	T _C = +25°C	17	-	-	А
Thermal Resistance	$R_{ heta JC}$		-	-	-	1.5	°C/W

Typical Performance Curves

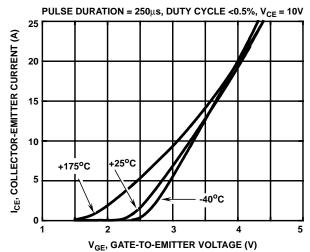


FIGURE 1. TRANSFER CHARACTERISTICS

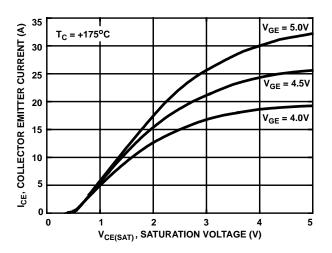


FIGURE 3. COLLECTOR-EMITTER CURRENT AS A FUNCTION OF SATURATION VOLTAGE

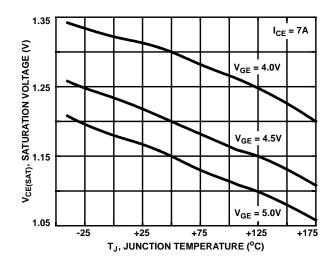


FIGURE 5. SATURATION VOLTAGE AS A FUNCTION OF JUNCTION TEMPERATURE

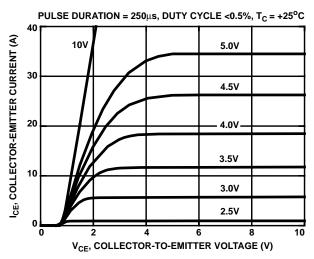


FIGURE 2. SATURATION CHARACTERISTICS

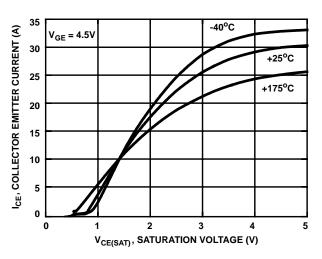


FIGURE 4. COLLECTOR-EMITTER CURRENT AS A FUNCTION OF SATURATION VOLTAGE

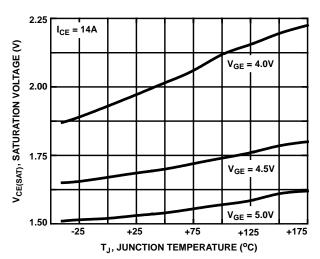


FIGURE 6. SATURATION VOLTAGE AS A FUNCTION OF JUNCTION TEMPERATURE

Typical Performance Curves (Continued)

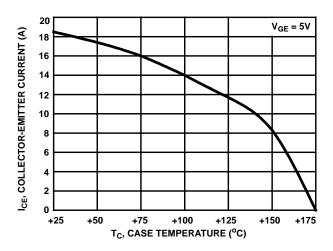


FIGURE 7. COLLECTOR-EMITTER CURRENT AS A FUNCTION OF CASE TEMPERATURE

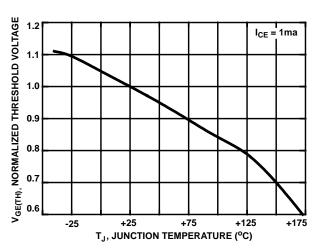


FIGURE 8. NORMALIZED THRESHOLD VOLTAGE AS A FUNCTION OF JUNCTION TEMPERATURE

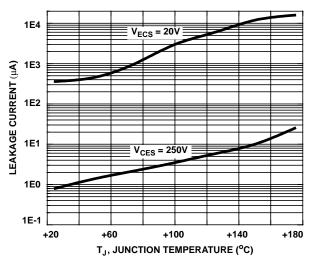


FIGURE 9. LEAKAGE CURRENT AS A FUNCTION OF JUNCTION TEMPERATURE

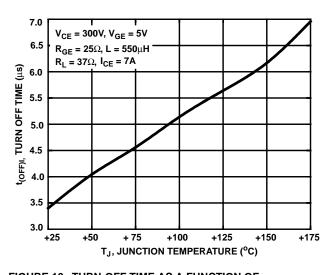


FIGURE 10. TURN-OFF TIME AS A FUNCTION OF JUNCTION TEMPERATURE

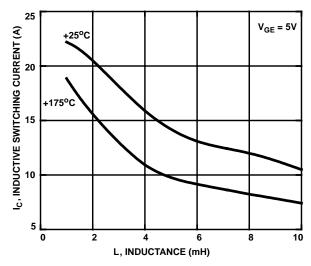


FIGURE 11. SELF CLAMPED INDUCTIVE SWITCHING
CURRENT AS A FUNCTION OF INDUCTANCE

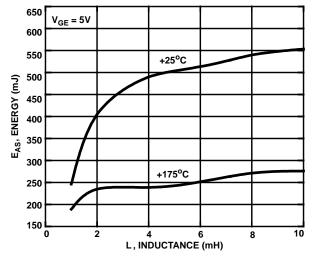


FIGURE 12. SELF CLAMPED INDUCTIVE SWITCHING ENERGY AS A FUNCTION OF INDUCTANCE

HGTP14N36G3VL, HGT1S14N36G3VL, HGT1S14N36G3VLS

Typical Performance Curves (Continued)

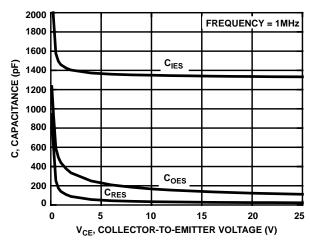


FIGURE 13. CAPACITANCE AS A FUNCTION OF COLLECTOR-EMITTER VOLTAGE

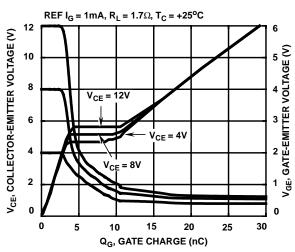


FIGURE 14. GATE CHARGE WAVEFORMS

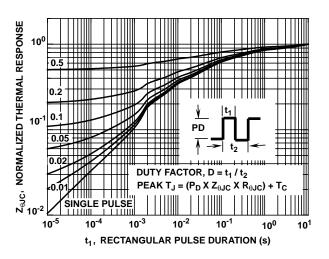


FIGURE 15. NORMALIZED TRANSIENT THERMAL IMPEDANCE, JUNCTION TO CASE

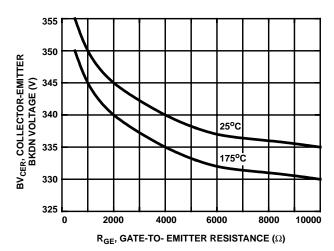


FIGURE 16. BREAKDOWN VOLTAGE AS A FUNCTION OF GATE-EMITTER RESISTANCE

Test Circuits

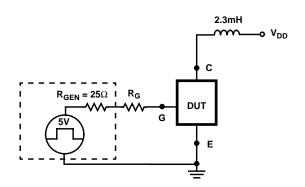


FIGURE 17. SELF CLAMPED INDUCTIVE SWITCHING CURRENT TEST CIRCUIT

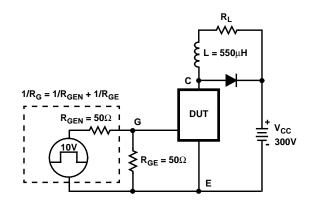


FIGURE 18. CLAMPED INDUCTIVE SWITCHING TIME TEST CIRCUIT

HGTP14N36G3VL, HGT1S14N36G3VL, HGT1S14N36G3VLS

Handling Precautions for IGBT's

Insulated Gate Bipolar Transistors are susceptible to gate-insulation damage by the electrostatic discharge of energy through the devices. When handling these devices, care should be exercised to assure that the static charge built in the handler's body capacitance is not discharged through the device. With proper handling and application procedures, however, IGBT's are currently being extensively used in production by numerous equipment manufacturers in military, industrial and consumer applications, with virtually no damage problems due to electrostatic discharge. IGBT's can be handled safely if the following basic precautions are taken:

- Prior to assembly into a circuit, all leads should be kept shorted together either by the use of metal shorting springs or by the insertion into conductive material such as †"ECCOSORBD LD26" or equivalent.
- 2. When devices are removed by hand from their carriers, the hand being used should be grounded by any suitable means for example, with a metallic wristband.
- 3. Tips of soldering irons should be grounded.
- Devices should never be inserted into or removed from circuits with power on.
- Gate Voltage Rating -The gate-voltage rating of V_{GEM} may be exceeded if I_{GEM} is limited to 10mA.
- † Trademark Emerson and Cumming, Inc

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4,364,073	4,417,385	4,430,792	4,443,931	4,466,176	4,516,143	4,532,534	4,567,641
4,587,713	4,598,461	4,605,948	4,618,872	4,620,211	4,631,564	4,639,754	4,639,762
4,641,162	4,644,637	4,682,195	4,684,413	4,694,313	4,717,679	4,743,952	4,783,690
4,794,432	4,801,986	4,803,533	4,809,045	4,809,047	4,810,665	4,823,176	4,837,606
4,860,080	4,883,767	4,888,627	4,890,143	4,901,127	4,904,609	4,933,740	4,963,951
4,969,027							

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